

20A, 100V Low V_F Trench Schottky Rectifier

FEATURES

- Patented Trench Schottky technology
- Excellent high temperature stability
- Low forward voltage
- Low power loss/ High efficiency
- High forward surge capability
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- Switching mode power supply (SMPS)
- Adapters
- DC to DC converters

MECHANICAL DATA

• Case: TO-220AB

Molding compound meets UL 94V-0 flammability rating

• Terminal: Matte tin plated leads, solderable per J-STD-002

Mounting torque: 0.56 N·m maximum
Meet JESD 201 class 1A whisker test

• Polarity: As marked

• Weight: 1.88g (approximately)

KEY PARAMETERS				
PARAMETER	VALUE	UNIT		
I _F	20	Α		
V_{RRM}	100	V		
I _{FSM}	150	Α		
T _{J MAX}	150	°C		
Package	TO-220AB			
Configuration	Dual dies			

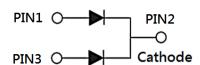








TO-220AB



ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)				
PARAMETER	SYMBOL	TST20U100C	UNIT	
Marking code on the device		TST20U100C		
Repetitive peak reverse voltage	V_{RRM}	100	V	
Reverse voltage, total rms value	V _{R(RMS)}	70	V	
Forward current	I _F	20	А	
Surge peak forward current, 8.3ms single half sine wave superimposed on rated load	I _{FSM}	150	А	
Junction temperature	T _J	-55 to +150	°C	
Storage temperature	T _{STG}	-55 to +150	°C	

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TST20U100C Taiwan Semiconductor

THERMAL PERFORMANCE				
PARAMETER	SYMBOL	TYP	TINU	
Junction-to-case thermal resistance	R _{eJC}	2.5	°C/W	

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage per diode ⁽¹⁾	I _F = 5A, T _J = 25°C	V _F	0.56	-	V
	$I_F = 10A, T_J = 25^{\circ}C$		0.65	0.79	V
	I _F = 5A, T _J = 125°C		0.49	-	V
	I _F = 10A, T _J = 125°C		0.58	0.68	V
Reverse current @ rated V _R per diode ⁽²⁾	T _J = 25°C	I _R	-	500	μΑ
	T _J = 125°C		-	25	mA

Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION			
ORDERING CODE	PACKAGE	PACKING	
TST20U100C	TO-220AB	50 / Tube	

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CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Fig.1 Forward Current Derating Curve

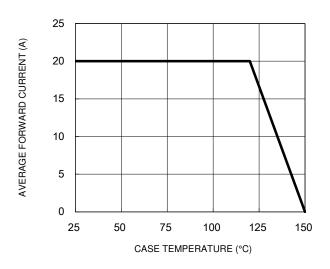


Fig.3 Typical Reverse Characteristics

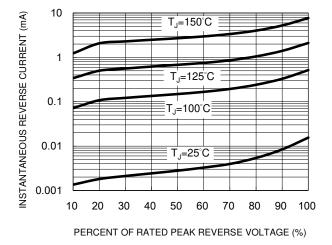


Fig.2 Typical Junction Capacitance

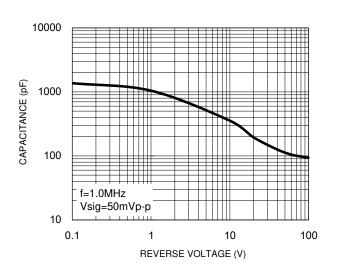
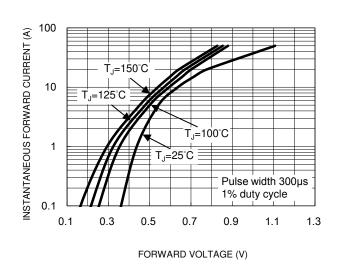


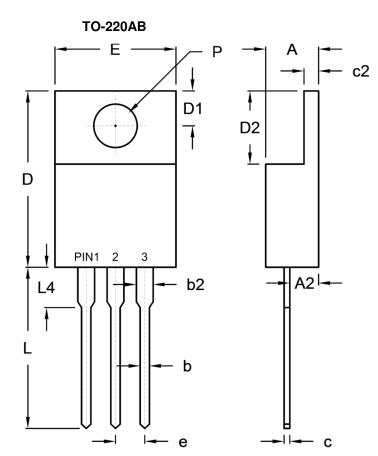
Fig.4 Typical Forward Characteristics







PACKAGE OUTLINE DIMENSIONS



DIM.	Unit (mm)		Unit (inch)		
Dilvi.	Min.	Max.	Min.	Max.	
Α	4.42	4.76	0.174	0.187	
A2	2.20	2.80	0.087	0.110	
b	0.68	0.94	0.027	0.037	
b2	1.14	1.77	0.045	0.070	
С	0.35	0.64	0.014	0.025	
c2	1.14	1.40	0.045	0.055	
D	14.60	16.00	0.575	0.630	
D1	2.62	3.44	0.103	0.135	
D2	5.84	6.86	0.230	0.270	
E	-	10.50	-	0.413	
е	2.41	2.67	0.095	0.105	
L	13.19	14.79	0.519	0.582	
L4	2.80	4.20	0.110	0.165	
Р	3.54	4.00	0.139	0.157	

MARKING DIAGRAM



P/N = Marking Code = Green Compound G

YWW = Date Code F = Factory Code



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